

41. (Currently Amended) The method of manufacturing a capacitor of an integrated circuit device ~~A capacitor of an integrated circuit device~~ as claimed in claim 38, wherein the barrier layer is uniformly formed to a predetermined thickness.

42. (Currently Amended) The method of manufacturing a capacitor of an integrated circuit device ~~A capacitor of an integrated circuit device~~ as claimed in claim 38, wherein the lower electrode is uniformly formed to a predetermined thickness.

43. (Currently Amended) The method of manufacturing a capacitor of an integrated circuit device ~~A capacitor of an integrated circuit device~~ as claimed in claim 38, wherein the dielectric layer is uniformly formed to a predetermined thickness.

44. (Currently Amended) The method of manufacturing a capacitor of an integrated circuit device ~~A capacitor of an integrated circuit device~~ as claimed in claim 38, wherein the upper electrode is uniformly formed to a predetermined thickness.

REMARKS

Claims 38-44 are presented for examination. Claims 1-37 have been cancelled. The preamble of each of Claims 41-44, which claims depend from Claim 38, has been amended to properly identify them as *method* claims.

The claims of parent application Serial No. 10/141,881 were subject to a requirement for restriction as set forth in the Action mailed December 16, 2002, and a further requirement for election of species as set forth in the Action mailed April 7, 2003. Claims 38-44, directed to non-elected species III, are presented for examination in this divisional application.

Applicants reserve the right to file additional divisional application(s) directed to other non-elected subject matter.

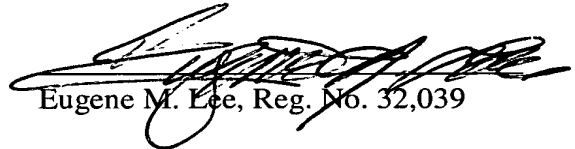
The accompanying text for the specification and claims has been presented in accordance with the guidelines set forth in the notice entitled "Pre-Grant Publication Helpful Hint" of September 12, 2001, authored by Deputy Commissioner for Patent Examination Policy Stephen G. Kunin. Specifically, the specification reflects changes identical to amendments presented and entered in the parent application.

Action on the merits is solicited.

Respectfully submitted,

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Date: October 10, 2003



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PETITION and
DEPOSIT ACCOUNT CHARGE AUTHORIZATION

This document and any concurrently filed papers are believed to be timely. Should any extension of the term be required, applicant hereby petitions the Director for such extension and requests that any applicable petition fee be charged to Deposit Account No. 50-1645.

If fee payment is enclosed, this amount is believed to be correct. However, the Director is hereby authorized to charge any deficiency or credit any overpayment to Deposit Account No. 50-1645.

Any additional fee(s) necessary to effect the proper and timely filing of the accompanying-papers may also be charged to Deposit Account No. 50-1645.